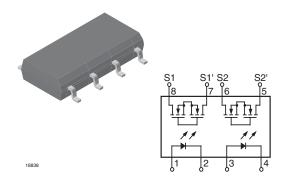
## Vishay Semiconductors



## **Dual 1 Form A Solid State Relay**



### DESCRIPTION

The LH1532FP is a dual 1 form A (SPST) which can replace electromechanical relays in many applications. They are constructed using a GaAlAs LED for activation control and an integrated monolithic die for the switch output. The die is comprised of a photodiode array, switch control circuity and MOSFET switches. The SSR features low on-resistance, high breakdown voltage and current-limit circuitry that protects the relay from telephone line induced lightning surges.

### AGENCY APPROVALS

UL1577: file no. E52744 system code O

### FEATURES

- Solid-state relay (equivalent to AQW210S)
  - Typical R<sub>ON</sub> 20  $\Omega$
  - Load voltage 350 V
  - Load current 120 mA
  - Current limit protection
  - High surge capability
  - Clean bounce free switching
  - Low power consumption
  - High reliability monolithic receptor
- Two independent relays in a single package
- Package flat pak
- Isolation test voltage, 3000 V<sub>RMS</sub>
- · Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

### **APPLICATIONS**

- General telecom switching
  - On/off hook control
  - Ring relay
  - Ground start
- Industrial controls
  - Triac predriver
- Output modules
- Peripherals
  - Transducer driver
- Instrumentation
  - Automatic tuning/balancing
  - Flying capacitor
  - Analog multiplexing

#### Note

See "solid state relays" (application note 56)

ORDER INFORMATION				
PART	REMARKS	PACKAGE		
LH1532FP	Tubes	SOP-8		
LH1532FPTR	Tape and reel	SOP-8		





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ABSOLUTE MAXIMUM RATINGS <sup>(1)</sup>							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
SSR							
LED continuous forward current		١ <sub>F</sub>	50	mA			
LED reverse voltage	I <sub>R</sub> ≤ 10 μA	V <sub>R</sub>	6.0	V			
DC or peak AC load voltage	$I_L \le 50 \ \mu A$	VL	350	V			
Continuous DC load current		١L	120	mA			
Ambient temperature range		T <sub>amb</sub>	- 40 to + 85	°C			
Storage temperature range		T <sub>stg</sub>	- 40 to + 125	°C			
Soldering temperature <sup>(2)</sup>	t = 10 s max.	T <sub>sld</sub>	260	°C			
Isolation test voltage	t = 1.0 s	V <sub>ISO</sub>	3000	V <sub>RMS</sub>			
Isolation resistance	$V_{IO} = 500 \text{ V}, \text{ T}_{amb} = 25 ^{\circ}\text{C}$	R <sub>IO</sub>	≥ 10 <sup>12</sup>	Ω			
	$V_{IO} = 500 \text{ V}, \text{ T}_{amb} = 100 ^{\circ}\text{C}$	R <sub>IO</sub>	≥ 10 <sup>11</sup>	Ω			
Total power dissipation		P <sub>tot</sub>	600	mW			

#### Notes

<sup>(1)</sup>  $T_{amb} = 25 \text{ °C}$ , unless otherwise specified.

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

<sup>(2)</sup> Refer to reflow profile for soldering conditions for surface mounted devices.

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
LED forward current, switch turn-on	I <sub>L</sub> = 100 mA, t = 10 ms	I <sub>Fon</sub>		1.2	3.0	mA
LED forward current, switch turn-off	$V_L = \pm 300 V$	I <sub>Foff</sub>	0.2			mA
LED forward voltage	I <sub>F</sub> = 10 mA	V <sub>F</sub>	1.0	1.22	1.5	V
OUTPUT						
On-resistance	$I_{F} = 5.0 \text{ mA}, I_{L} = \pm 50 \text{ mA}$	R <sub>ON</sub>		20	25	Ω
Off-resistance	$I_{F} = 0 \text{ mA}, V_{L} = \pm 100 \text{ V}$	R <sub>OFF</sub>		5000		GΩ
Current limit	$I_F = 5.0 \text{ mA}, t = 5.0 \text{ ms}$	I <sub>Limit</sub>	170	210	250	mA
Output off-state leakage current	$I_{F} = 0 \text{ mA}, V_{L} = \pm 100 \text{ V}$	Ι <sub>Ο</sub>		0.6	200	nA
	$I_{F} = 0 \text{ mA}, V_{L} = \pm 350 \text{ V}$	Ι <sub>Ο</sub>			1.0	μΑ
Output capacitance	$I_F = 0 \text{ mA}, V_L = \pm 1.0 \text{ V}$	Co		55		pF
Pole-to-pole capacitance (S1 to S2)	I <sub>F</sub> = 5.0 mA			0.5		pF
TRANSFER						
Turn-on time	$I_F = 5.0 \text{ mA}, I_L = 50 \text{ mA}$	t <sub>on</sub>		1.1	2.5	ms
Turn-off time	$I_{F} = 5.0 \text{ mA}, I_{L} = 50 \text{ mA}$	t <sub>off</sub>		0.06	2.5	ms
Switch offset	l <sub>F</sub> = 5.0 mA	V <sub>OS</sub>		0.15		μV

#### Note

 $T_{amb} = 25$  °C, unless otherwise specified.

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

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Dual 1 Form A Solid State Relay



### **TYPICAL CHARACTERISTICS**

T<sub>amb</sub> = 25 °C, unless otherwise specified

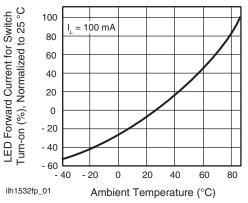


Fig. 1 - LED Current for Switch Turn-on vs. Temperature

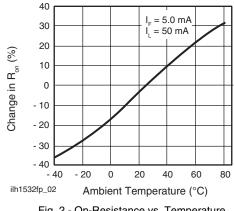
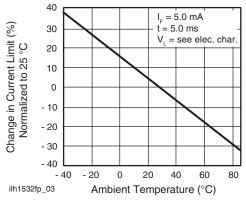


Fig. 2 - On-Resistance vs. Temperature





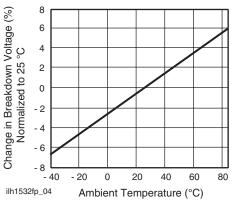


Fig. 4 - Switch Breakdown Voltage vs. Temperature

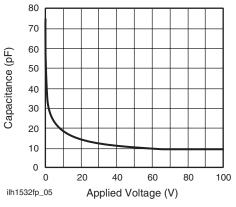
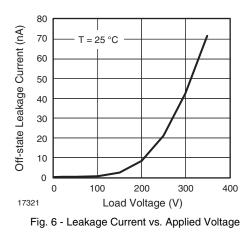


Fig. 5 - Switch Capacitance vs. Applied Voltage





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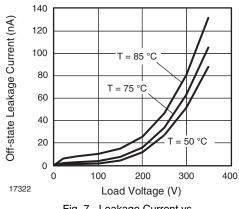


Fig. 7 - Leakage Current vs. Applied Voltage at Elevated Temperatures

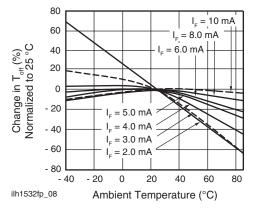
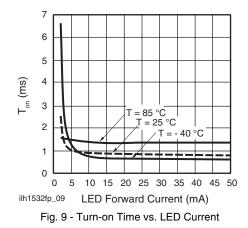


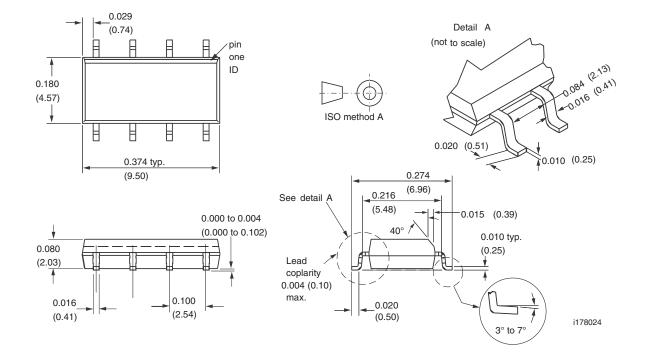
Fig. 8 - Turn-off Time vs. Temperature



## Vishay Semiconductors Dual 1 Form A Solid State Relay



### PACKAGE DIMENSIONS in inches (millimeters)







Dual 1 Form A Solid State Relay

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### **OZONE DEPLETING SUBSTANCES POLICY STATEMENT**

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



Vishay

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